

Product Change Notification

Change Notification #: 114508 - 01

Change Title: Intel® SSD DC S3500 Series (1.2TB,

1.6TB, 2.5in SATA 6Gb/s, 20nm, MLC)

7mm, Generic Single Pack,

Intel® SSD DC S3500 Series (1.2TB, 1.6TB, 2.5in SATA 6Gb/s, 20nm, MLC)

7mm, Generic 50 Pack,

Intel® SSD DC S3500 Series (80GB, 120GB, 340GB, M.2 80mm SATA 6Gb/s, 20nm, MLC) Dual Sided, Generic Single

Pack,

Intel® SSD DC S3500 Series (80GB, 120GB, 340GB, M.2 80mm SATA 6Gb/s, 20nm, MLC) Dual Sided, Generic 100

Pack,

PCN 114508-01, Product Design,

Firmware Update

Reason for Revision: Extend Customer

Ready to Receive Milestone

Date of Publication: May 9, 2016

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: June 30, 2016

Reason for Revision: Intel will be extending the Customer Must be Ready to Receive Post-Conversion Material milestone from May 30, 2016 to June 30, 2016.

No other changes have been made to the PCN.

Description of Change to the Customer:

The Intel® SSD DC S3500 Series firmware version is being updated from G2010140 to G2010150. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version. Customers should be ready to receive the post-conversion material any time after June 30, 2016.

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
SSDSC2BB016T4	929754	H39693-301	H39692-301	H39693-302	H39692-302
SSDSC2BB016T401	929756	H39691-301	H39692-301	H39691-302	H39692-302
SSDSCKHB080G4	932261	H25291-202	H25292-201	H25291-203	H25292-202
SSDSCKHB120G4	932262	H25294-202	H25295-201	H25294-203	H25295-202
SSDSCKHB340G4	932263	H25297-202	H25298-201	H25297-203	H25298-202
SSDSCKHB080G401	932264	H25293-201	H25292-201	H25293-202	H25292-202
SSDSCKHB120G401	932265	H25296-201	H25295-201	H25296-202	H25295-202
SSDSCKHB340G401	932266	H25299-201	H25298-201	H25299-202	H25298-202
SSDSC2BB012T401	932567	H39694-301	H39695-301	H39694-302	H39695-302
SSDSC2BB012T4	932568	H39696-301	H39695-301	H39696-302	H39695-302

PCN Revision History:

Date of Revision:Revision Number:Reason:March 31, 201600Originally Published PCNMay 9, 201601Extend Customer Ready to Receive Milestone



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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